Intel Product Change Notification

Change Notification #:	117198 - 02
Change Title:	Select Intel® SSD D3-S4510 Series,
	PCN 117198-02, Product Design, Product
	Material,
	Firmware Update and Add Additional
	DRAM Suppliers,
	Reason for Revision: Correction to Year of
	Publication Date
Date of Publication:	March 19, 2020

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

 Date Customer Must be Ready to Receive Post-Conversion Material:
 January 23, 2020

Description of Change to the Customer:

Reason for Revision: Correction to Year of Publication Date

The Intel® SSD D3-S4510 Series SKUs listed in the Products Affected table below will have the following changes.

- The firmware version is being updated from XC311102 to XC311120. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.
- Intel is adding additional DRAM from Hynix*, Nanya*, as approved vendors in order to ensure that there is supply continuity for the product lines.

Product Code	MM#	Changes
SSDSCKKB240G8	963514	Nanya* will be added as an alternate DRAM
SSDSCKKB240G801	963510	
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Product Code	MM#	Changes
SSDSCKKB480G8	963515	Nanya* will be added as an alternate DRAM
SSDSCKKB480G801	963511	Hynix* will be added as an alternate DRAM
SSDSCKKB960G8	963516	
SSDSCKKB960G801	963512	

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

For your information only. No change to form fit or function. No change to Intel Ordering codes.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change	Pre Change	Post Change	Post Change
Warkeing Name	1 Touter Coue	141141//	TA	SA	TA	SA
			IA	BA	IA	BA
Intel® SSD D3-S4510 Series (240GB, M.2 80mm	SSDSCKKB240G801	963510	J97138-101	J97319-101	J97138-102	J97319-102
SATA 6Gb/s, 3D2, TLC) Generic Single Pack						
Intel® SSD D3-S4510 Series (480GB, M.2 80mm	SSDSCKKB480G801	963511	J97139-101	J97320-101	J97139-102	J97320-102
SATA 6Gb/s, 3D2, TLC) Generic Single Pack						
Intel® SSD D3-S4510 Series (960GB, M.2 80mm	SSDSCKKB960G801	963512	J97140-101	J97321-101	J97140-102	J97321-102
SATA 6Gb/s, 3D2, TLC) Generic Single Pack						
Intel® SSD D3-S4510 Series (240GB, M.2 80mm	SSDSCKKB240G8	963514	J97144-101	J97319-101	J97144-102	J97319-102
SATA 6Gb/s, 3D2, TLC) Generic 50 Pack						
Intel® SSD D3-S4510 Series (480GB, M.2 80mm	SSDSCKKB480G8	963515	J97156-101	J97320-101	J97156-102	J97320-102
SATA 6Gb/s, 3D2, TLC) Generic 50 Pack						
Intel® SSD D3-S4510 Series (960GB, M.2 80mm	SSDSCKKB960G8	963516	J97176-101	J97321-101	J97176-102	J97321-102
SATA 6Gb/s, 3D2, TLC) Generic 50 Pack						

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 25, 2019	00	Originally Published PCN
March 05, 2020	01	Update Product Code Text
March 19, 2020	02	Correction to Year of Publication
		Date

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: <u>asmo.pcn@intel.com</u> Asia Pacific/PRC Contact: <u>apacgccb@intel.com</u> Europe Email: <u>eccb@intel.com</u> Japan Email: jccb.ijkk@intel.com

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